# PRODUCT / PROCESS CHANGE NOTIFICATION

Generic Copy
PCN#2303002 • DATE: 28 <sup>th</sup> March, 2023
PCN Subject: Additional Assembly Site for Package SOT-363
PCN Change Category:
■ Material ■ Process □ Datasheet/Specification □ Reliability
Others ( Additional assembly site )
Description of Change Purpose or Reason:
This PCN is being issued to announce the qualification of PANJIT Semiconductor
(Xuzhou) Co., Ltd (located in Jiangsu Province, China) as an alternate assembly
and test site for SOT-363 selected products. The products that will be
manufactured from this new assembly/test site are form, fit, and function compatible
with the current qualified manufacturing sites. The qualification incorporates new bill
of material (BOM) sets including the utilization of High-Density Leadframe, the
change of wire type and wire diameter. For more detail, please check below change
information.
We recommend that you acknowledge receipt of this notification within 30 days
of this PCN date. If you require samples for further evaluation, please feel free to
contact your local sales representative and make a request. We are always pleased

to serve you at any time.

# • Change Information:

Comparison		Table 1			
			Current	Add	
Assembly Site		PANJIT International Inc.	PANJIT Semiconductor (Xuzhou Co., Ltd.		
	Location		Kaohsiung, Taiwan	Xuzhou, China	
		Supplier	Phenitec Semiconductor Corp.	Yangzhou Genesis Microelectronics Co., Ltd	
	Wafer	Diameter (inch)	5"		
		Die Size(um)	MMDT2907AQ: 400 X 400 MMDT3906: 280 X 280	MMDT2907AQ: 460 X 460 MMDT3906: 260 X 260	
		Thickness (um)	$230 \pm 20$	165 ± 15	
	Lead Frame	Material	Alloy 42		
	Wire	Material / Diameter (mil)	Ag / 1.0 Au / 1.0	Cu / 0.8	
	Epoxy Molding Compound	Product Name	ELER-8-500C-84	GR640HV-L1 B18	
	Carrier Tape	Material	Polycarbonate (PC)	Polystyrene (PS)	
Material	Material Ending Tape	Material	Polyester	Paper	
	Ending rape	Color	Black	Yellow	
	Blue Anti-Static Plastic Reel				
Method	Process	De-Flash	Electrolytic De-flash	Chemical De-flash	
Form	Mark	king Format	8KDH	M7Q K	

# • Change Information:

Comparison		Table 2			
			Current	Add	
Assembly Site		PANJIT International Inc.	PANJIT Semiconductor (Xuzhou Co., Ltd.		
	Location		Kaohsiung, Taiwan	Xuzhou, China	
		Supplier	Mosel Vitelic Inc.		
	Wafer	Diameter (inch)	6"		
	vvaler	Die Size(um)	360 x 360		
		Thickness (um)	152		
	Lead Frame	Material	Alloy 42		
	Wire	Material / Diameter (mil)	Cu / 1.0	Cu / 0.8	
	Epoxy Molding Compound	Product Name	ELER-8-500C-84	GR640HV-L1 B18	
	Carrier Tape	Material	Polycarbonate (PC)	Polystyrene (PS)	
Material	Ending Tape	Material	Polyester	Paper	
Material	Ending rape	Color	Black	Yellow	
	Blue Anti-Static Plastic Reel				
Method	Process	De-Flash	Electrolytic De-flash	Chemical De-flash	
Form	Mark	king Format	SKDH	Add bar "-" for new assembly sit	

# • Change Information:

Carrier Tape	Current	Add
Assembly Site	PANJIT International Inc.	PANJIT Semiconductor (Xuzhou) Co., Ltd.
Dimension	Do Po	P2  P1  Representation of the second of the
Symbol (mm)	Dimension	Dimension
Ao	2.16 ± 0.10 2.28 ± 0.10	2.30 ± 0.10
Ко	1.07 ± 0.10 1.10 ± 0.10	1.22 ± 0.10
Cd	0.15 MAX.	0.20 MAX.

### Verification /Qualification Data:

The electrical characterization and high reliability testing have been completed on representative part numbers to ensure there is no change to device functionality or electrical specifications in the datasheet. There will be no change to the Form, Fit, or Function of products affected unless specifically indicated.

### • Affected Product Type:

### Table 1:

Function: Bipolar Junction Transistors		
MMDT2907AQ	MMDT3906	

#### Table 2:

Function:	MOSFET
PJT138K	

• Effective Date: 28<sup>th</sup> June, 2023

### > The reliability test results are summarized below:

Product reliability test result: PASS

No.	DESCRIPTION	TEST CONDITION	DURATION	FAILUR	E RATE
1	Temperature Cycling (TCT)	Ta = -55°C ~ +150°C ( 2 cycles / Hour )	1000 CYCLES	0/77 PCS	3 LOTS PASS
2	High Temperature Storage Test (HTSL)	Ta = 150°C	1000 HOURS	0/77 PCS	3 LOTS PASS
3	Resistance to Solder Heat (RSH)	Temperature of solder pot = 260 ±5°C Time for dipping in solder = 10 +2/-0 Sec	1 CYCLE	0/30 PCS	3 LOTS PASS
4	Solder ability (SD)	Temperature of solder pot = 245 ±5°C Time for dipping in solder = 5 ±0.5 Sec	1 CYCLE	0/10 PCS	3 LOTS PASS
5	Intermittent Forward Operation Life (IFOL)	△Tj≥100°C Power On: 120 sec Power Off: 120 sec	15000 CYCLES	0/77 PCS	3 LOTS PASS
6	High Temperature Reverse Bias (HTRB)	Ta = 140°C , VR = 80%VB, DC supply	1000 HOURS	0/77 PCS	3 LOTS PASS
7	High Temperature Gate Bias (HTGB)	Tj≦Tj max, 100%VGS	1000 HOURS	0/77 PCS	3 LOTS PASS
8	Autoclave (AC)	Ta = 121°C, P = 29.7psia ,100%RH	96 HOURS	0/77 PCS	3 LOTS PASS
9	Temperature Humidity Storage (THS)	Ta = 85°C , RH = 85%	1000 HOURS	0/77 PCS	3 LOTS PASS

### • ELECTRICAL CHARACTERISTICS SUMMARY:

There is no change to the product electrical specifications.

### SAMPLES NEED :

Contact your local PANJIT sales representative.

### • TECHNICAL CONTACT:

E-mail: alanliu@panjit.com.tw

### FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:

Contact your local PANJIT sales representative.

### ADDITIONAL RELIABILITY:

Contact your local PANJIT sales representative.

### CHANGED PART IDENTIFICATION :

The tracking of 1<sup>st</sup> delivery after change can be identified by production lot number. Please contact your local sales for tracking lot number.

Please refer to below Lot number rule:

Lot number: 2924XXXXX.

1st digit "2" denotes Year 2022. 2nd digit "9" denotes September. 3rd and 4th digits denote Day.

From 5<sup>th</sup> digits (XXXXX) denotes production serial number.

### **Customer Acknowledgement Form**

(To be filled out by the cus	tomer and returned to HQBU of PANJIT)	
The indicated Customer Notification letter authority.	was received and acknowledged by the undersig	ned
Company Name :	_	
Customer Name :	_(Signature) Date :	
PCN Number : PCN#2303002		
Approval for the Product/Process change:	□Yes □No	
Comments/Additional requests:		
Thanks for your attention on this matter. Pl PANJIT sales representative.	lease return the acknowledgment form to your loo	cal

Please note that no objection within 30 days upon receiving will be deemed as being accepted and agreed with this Process Change Notification.